

PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	ADG/24/14592	
1.3 Title of PCN	TO-220FP line transfer from Shenzhen to TFME Tongke (China)	
1.4 Product Category	IGBT's	
1.5 Issue date	2024-03-12	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Angelo RAO
2.1.2 Marketing Manager	Natale Sandro D'ANGELO
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	TFME Tongke (China)

4. Description of change

	Old	New
4.1 Description	TO-220FP products are manufactured in Shenzhen (China)	TO-220FP products are manufactured in TFME Tongke (China)
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	processability	

5. Reason / motivation for change

5.1 Motivation	TO-220FP Shenzhen line closure and equipment transfer to TFME Tongke
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	By dedicated FG codes
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7. Timing / schedule

7.1 Date of qualification results	2024-02-19
7.2 Intended start of delivery	2024-05-19
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	14592 RERPTD24010_1.0_TO220FP package Transfer from STS to Tongke subcon for IGBT and Bipolar transistor products.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2024-03-12

9. Attachments (additional documentations)

14592 Public product.pdf
14592 14592.pdf
14592 RERPTD24010_1.0_TO220FP package Transfer from STS to Tongke subcon for IGBT and Bipolar transistor products.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
BUL1102EFP	BUL1102EFP	
	STGF30M65DF2	
	STGF4M65DF2	

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